



The Water Soluble Paste Flux is a specially formulated, Water Soluble, Water Flushable Solder Flux for use with 95/5, 60/40, 50/50, 40/60 and Lead Free Solders on Copper, Copper Alloys, Brass, Galvanized Iron, Tin, Steel, Terne Plate, Zinc, Silver, Nickel and Sheet Lead

Specifications

Category	Description
Usage	Solder Flux for use with 95/5, 60/40, 50/50, 40/60 and Lead Free Solders on Copper, Copper Alloy, Brass, Galvanized Iron, Tin, Steel, Terne Plate, Zinc, Silver, Nickel and Sheet Lead.
Temperature Range Use	0°F (-18°C) to 130°F (54°C)
Melting Temperature	140°F (72°C)
Consistency / Colour	Paste / Gold

- > Water Soluble
- > Fast Drawing
- > High Melt Point
- > Non-Fuming
- > Non-Corrosive
- > Self-Cleaning Formula
- > Convenient Screw-Top Lid
- > Zinc Chloride and Lead Free
- > Safe for Potable water
- > Non-acidic
- > Brushable and will not run or separate
- > Meets ASTM B813

Water Soluble Paste Flux is a water soluble, lead free paste soldering flux. It removes oxidation and prepares metals for the proper bonding of solder to metal to assure leak tight joints. It will not burn, char or spatter.